

June 1991 Revised January 1999

74ACTQ16646 16-Bit Transceiver/Register with 3-STATE Outputs

General Description

The ACTQ16646 contains sixteen non-inverting bidirectional registered bus transceivers providing multiplexed transmission of data directly from the input bus or from the internal storage registers. Each byte has separate control inputs which can be shorted together for full 16-bit operation. The DIR inputs determine the direction of data flow through the device. The CPAB and CPBA inputs load data into the registers on the LOW-to-HIGH transition. The ACTQ16646 utilizes Fairchild Quiet Series™ technology to guarantee quiet output switching and improved dynamic threshold performance. FACT Quiet Series™ features GTO™ output control and undershoot corrector for superior performance.

Features

- Utilizes Fairchild FACT Quiet Series technology
- Guaranteed simultaneous switching noise level and dynamic threshold performance
- Guaranteed pin-to-pin output skew
- Independent registers for A and B buses
- Multiplexed real-time and stored data transfers
- Separate control logic for each byte
- 16-bit version of the ACTQ646
- Outputs source/sink 24 mA
- Additional specs for Multiple Output Switching
- Output loading specs for both 50 pF and 250 pF loads

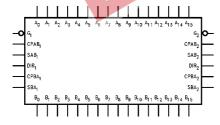
Pin Assignment for

Ordering Code:

Order Number	Package Number			Package Description	
74ACTQ16646SSC	MS56A	56-Lead Shrin	nk Small Out	tline Package (SSOP), JEDEC MO-118, 0.300" Wide	
74ACTQ16646MTD	MTD56	56-Lead Thin	Shrink Sma	Il Outline Package (TSSOP), JEDEC MO-153, 6.1mm	Wide

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code

Logic Symbol



Connection Diagram



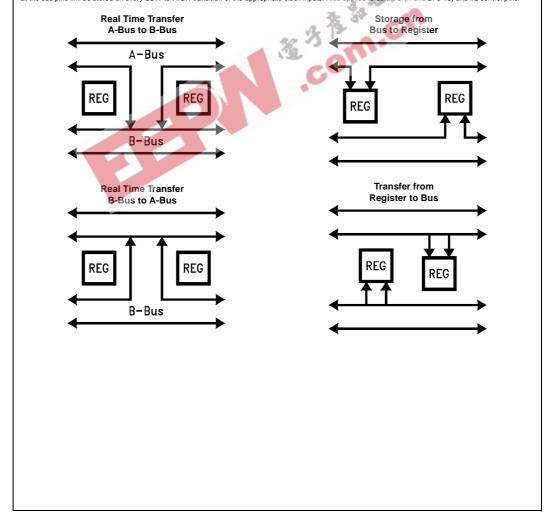
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Function Table

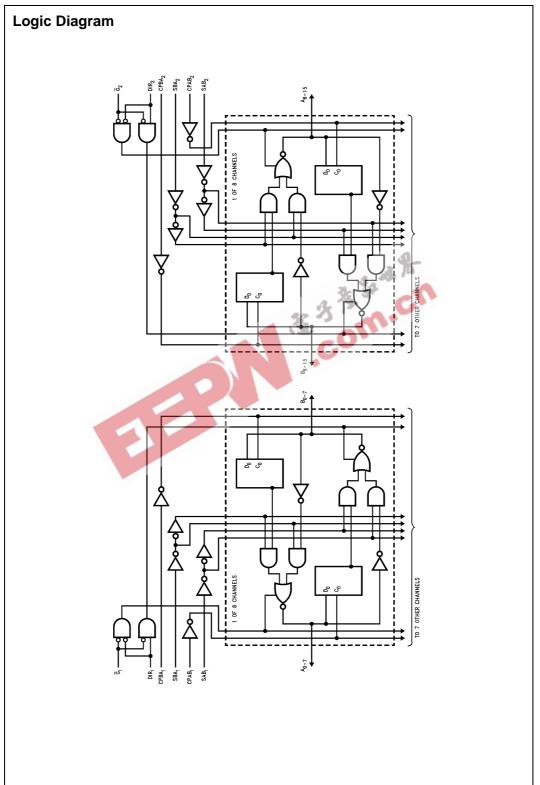
		Inp	uts			Data I/O (Note 1)		Output Operation Mode
G ₁	DIR ₁	CPAB ₁	CPBA ₁	SAB ₁	SBA ₁	A ₀₋₇	B ₀₋₇	
Н	Х	H or L	H or L	Х	Х			Isolation
Н	X	~	X	X	X	Input	Input	Clock An Data into A Register
Н	X	X	~	Χ	X			Clock Bn Data Into B Register
L	Н	Х	Х	L	Х			An to Bn—Real Time (Transparent Mode)
L	Н	~	X	L	X	Input	Output	Clock An Data to A Register
L	Н	H or L	X	Н	X			A Register to Bn (Stored Mode)
L	Н	~	X	Н	X			Clock An Data into A Register and Output to Bn
L	L	Х	Х	X	L			Bn to An—Real Time (Transparent Mode)
L	L	X	~	X	L	Output	Input	Clock Bn Data into B Register
L	L	X	H or L	X	Н			B Register to An (Stored Mode)
L	L	X	~	Χ	Н			Clock Bn into B Register and Output to An

H = HIGH Voltage Level L = LOW Voltage Level

Note 1: The data output functions may be enabled or disabled by various signals at the G and DIR inputs. Data input functions are always enabled; i.e., data at the bus pins will be stored on every LOW-to-HIGH transition of the appropriate clock inputs. Also applies to data I/O (A and B: 8-15) and #2 control pins.



X = Immaterial
_ = LOW-to-HIGH Transition.



Absolute Maximum Ratings(Note 2)

Supply Voltage (V_{CC}) -0.5V to +7.0V DC Input Diode Current (I_{IK})

 $V_1 = -0.5V$ -20 mA $V_I = V_{CC} + 0.5V$ +20 mA

DC Output Diode Current (I_{OK})

 $V_O = -0.5V$ -20 mA $V_O = V_{CC} + 0.5V$ +20 mA

DC Output Voltage (V_O) -0.5V to $\ensuremath{V_{CC}} + 0.5\ensuremath{V}$

DC Output Source/Sink Current (I_O)

DC V_{CC} or Ground Current

per Output Pin Storage Temperature

-65°C to +150°C

Recommended Operating Conditions

Supply Voltage (V_{CC}) 4.5V to 5.5V Input Voltage (V_I) 0V to $V_{\mbox{\footnotesize CC}}$ Output Voltage (V_O) 0V to $V_{\mbox{\footnotesize CC}}$ -40°C to $+85^{\circ}\text{C}$ Operating Temperature (T_A) Minimum Input Edge Rate (ΔV/Δt) 125 mV/ns

 $V_{\mbox{\footnotesize{IN}}}$ from 0.8V to 2.0V V_{CC} @ 4.5V, 5.5V

±50 mA

Note 2: Absolute maximum ratings are those values beyond which damage to the device may occur. The databook specifications should be met, without exception to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation of FACT™ circuits outside databook specifications.

DC Electrical Characteristics

Symbol	Parameter	V _{CC}			$T_A = -40^{\circ}C \text{ to} + 85^{\circ}C$	Units	Conditions	
Oyillboi	i didilictei	(V) Typ		Guaranteed Limits		Oilles	Conditions	
V _{IH}	Minimum HIGH	4.5	1.5	2.0	2.0	V	V _{OUT} = 0.1V	
	Input Voltage	5.5	1.5	2.0	2.0	(2)	or V _{CC} – 0.1V	
V _{IL}	Maximum LOW	4.5	1.5	0.8	0.8	V	V _{OUT} = 0.1V	
	Input Voltage	5.5	1.5	8.0	0.8		or V _{CC} – 0.1V	
V _{OH}	Minimum HIGH	4.5	4.49	4.4	4.4	V	I _{OUT} = -50 μA	
	Output Voltage	5.5	5.49	5.4	5.4			
							$V_{IN} = V_{IL}$ or V_{IH}	
		4.5		3.86	3.76	V	$I_{OH} = -24 \text{ mA}$	
		5.5		4.86	4.76		$I_{OH} = -24 \text{ mA (Note 3)}$	
V _{OL}	Maximum LOW	4.5	0.001	0.1	0.1	V	I _{OUT} = 50 μA	
	Output Voltage	5 .5	0.001	0.1	0.1			
							$V_{IN} = V_{IL}$ or V_{IH}	
		4.5		0.36	0.44	V	I _{OL} = 24 mA	
		5.5		0.36	0.44		I _{OL} = 24 mA (Note 3)	
I _{OZT}	Maximum I/O	5.5		±0.5	±5.0	μΑ	$V_{IN} = V_{IL}, V_{IH}$	
	Leakage Current						$V_O = V_{CC}$, GND	
I _{IN}	Maximum Input	5.5		±0.1	±1.0	μΑ	$V_I = V_{CC}$, GND	
	Leakage Current							
I _{CCT}	Maximum I _{CC} /Input	5.5	0.6		1.5	mA	$V_I = V_{CC} - 2.1V$	
I _{CC}	Max Quiescent	5.5		8.0	80.0	μΑ	$V_{IN} = V_{CC}$ or GND	
	Supply Current							
I _{OLD}	Minimum Dynamic	5.5			75	mA	V _{OLD} = 1.65V Max	
I _{OHD}	Output Current (Note 4)				-75	mA	V _{OHD} = 3.85V Min	
V _{OLP}	Quick Output	5.0	0.5	0.8		V	Figure 1, Figure 2	
	Maximum Dynamic V _{OL}						(Note 6)(Note 7)	
V _{OLV}	Quick Output	5.0	-0.5	-0.8		V	Figure 1, Figure 2	
	Minimum Dynamic V _{OL}						(Note 6)(Note 7)	
V _{OHP}	Maximum	5.0	V _{OH} + 1.0	V _{OH} + 1.5		V	Figure 1, Figure 2	
	Overshoot						(Note 5)(Note 7)	
V _{OHV}	Minimum	5.0	V _{OH} – 1.0	V _{OH} – 1.8		V	Figure 1, Figure 2	
	V _{CC} Droop						(Note 5)(Note 7)	
V _{IHD}	Minimum HIGH Dynamic	5.0	1.7	2.0		V	(Note 5)(Note 8)	
	Input Voltage Level							
V _{ILD}	Maximum LOW Dynamic	5.0	1.2	0.8		V	(Note 5)(Note 8)	
	Input Voltage Level							

Note 3: All outputs loaded; thresholds associated with output under test.

Note 4: Maximum test duration 2.0 ms; one output loaded at a time.

Note 5: Worst case package.

DC Electrical Characteristics (Continued)

 $\textbf{Note 6:} \ \text{Maximum number of outputs that can switch simultaneously is n. (n-1) outputs are switched LOW and one output held LOW.}$

 $\textbf{Note 7:} \ \text{Maximum number of outputs that can switch simultaneously is n. } (n-1) \ \text{outputs are switched HIGH and one output held HIGH.}$

Note 8: Maximum number of data inputs (n) switching. (n - 1) inputs switching 0V to 3V (ACTQ). Input under test switching 3V to threshold (V_{ILD}).

AC Electrical Characteristics

		V _{CC}		T _A = +25°	С	$T_A = -40^\circ$	C to +85°C	
Symbol	Parameter	(V)		$C_L = 50 p$	F	C _L =	50 pF	Units
		(Note 9)	Min	Тур	Max	Min	Max	
t _{PHL}	Propagation Delay	5.0	4.6	6.9	9.4	3.6	10.1	ns
t _{PLH}	Clock to Bus		4.3	6.5	8.9	3.3	9.7	
t _{PHL}	Propagation Delay	5.0	4.0	6.2	8.5	2.9	9.2	ns
t _{PLH}	Bus to Bus		4.1	6.4	8.6	3.2	9.3	
t _{PHL}	Propagation Delay	5.0	4.0	6.4	8.9	3.1	9.6	ns
t _{PLH}	Select to Bus		4.2	6.7	9.5	3.2	10.4	
	(w/An or Bn HIGH or LOW)							
t _{PZL}	Enable Time	5.0	5.3	7.8	10.5	3.8	11.4	ns
t_{PZH}	G to An/Bn		4.6	6.9	9.4	3 .3	10.2	
t _{PLZ}	Disable Time	5.0	3.0	5.5	8.1	2.3	8.6	ns
t _{PHZ}	G to An/Bn		3.4	5.7	8.3	2.6	8.6	
t _{PZL}	Enable Time	5.0	5.1	8.2	11.8	4.3	12.7	ns
t _{PZH}	DIR to An/Bn		4.6	7.5	10.8	3.7	11.7	
t _{PLZ}	Disable Time	5.0	2.9	5.8	9.2	2.0	9.8	ns
t _{PHZ}	DIR to An/Bn		3.4	6.1	9.2	2.5	9.7	

Note 9: Voltage Range 5.0 is $5.0V \pm 0.5V$.

AC Operating Requirements

Symbol	Parameter	V _{CC} (V)	T _A = +25°C C _L = 50 pF	$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ $C_L = 50 \text{ pF}$	Units
		(Note 10)	Guarantee	d Minimum	
t _S	Setup Time, H or L	5.0	3.0	3.0	ns
	Bus to Clock				
t _H	Hold Time, H or L	5.0	1.5	1.5	ns
	Bus to Clock				
t _W	Clock Pulse Width	5.0	4.0	4.0	ns
	H or L				

Note 10: Voltage Range 5.0 is 5.0V \pm 0.5V.

Extended AC Electrical Characteristics

		T _A	=-40°C to +85	5°C	T _A = -40°	C to +85°C	
			$V_{CC} = Com$		V _{CC} =	- Com	
			C _L = 50 pF			250 pF	
Symbol	Parameter	16	Outputs Switch	nina			Units
٠,	i alamoto.		(Note 12)	9	(Not	e 13)	00
		Min	Typ	Max	Min	Max	
t _{PHL}	Propagation Delay	4.1		10.1	6.1	14.5	ns
t _{PLH}	Clock to Bus	4.2		10.1	6.0	14.8	
t _{PHL}	Propagation Delay	4.0		10.0	5.4	13.7	ns
t _{PLH}	Bus to Bus	4.7		10.7	5.9	13.5	
t _{PHL}	Propagation Delay	3.8		9.6	5.7	14.2	ns
t _{PLH}	Select to Bus	4.3		10.9	6.1	15.5	
	(w/An or Bn HIGH or LOW)						
t _{PZL}	Enable Time	5.0		12.7	(Not	e 14)	ns
t _{PZH}	G to An/Bn	4.1		11.3			
t _{PLZ}	Disable Time	3.2		8.3	(Not	e 15)	ns
t _{PHZ}	G to An/Bn	3.5		8.6	- Par		
t _{PZL}	Enable Time	4.1		11.3	(Not	e 14)	ns
t _{PZH}	DIR to An/Bn	4.4	21	13.0	-		
t _{PLZ}	Disable Time	2.9	1 1	9.5	(Not	e 15)	ns
t _{PHZ}	DIR to An/Bn	3.4	20 73	9.7			
toshl	Pin-to-Pin Skew		772	1.0			ns
(Note 11)	Clock to Bus		-) •			
toslh	Pin-to-Pin Skew			1.0			ns
(Note 11)	Clock to Bus		-				
toshl	Pin-to-Pin Skew			1.0			ns
(Note 11)	Bus to Bus						
toslh	Pin-to-Pin Skew			1.0			ns
(Note 11)	Bus to Bus						
toshl	Pin-to-Pin Skew						
(Note 11)	Select to Bus			1.0			ns
	(w/An or Bn HIGH or LOW)						
toslh	Pin-to-Pin Skew						
(Note 11)	Select to Bus			1.2			ns
	(w/An or Bn HIGH or LOW)						
t _{OST}	Pin-to-Pin Skew			2.1			ns
(Note 11)	Clock to Bus						
t _{OST}	Pin-to-Pin Skew			1.0			ns
(Note 11)	Bus to Bus						
t _{OST}	Pin-to-Pin Skew			2.7			ns
(Note 11)	Select to Bus						

Note 11: Skew is defined as the absolute value of the difference between the actual propagation delays for any two separate outputs of the same device. The specification applies to any outputs switching HIGH to LOW (toshL), LOW to HIGH (toshH), or any combination switching LOW to HIGH and/or HIGH to LOW (tosh).

Note 12: This specification is guaranteed but not tested. The limits apply to propagation delays for all paths described switching in phase (i.e., all LOW-to-HIGH, HIGH-to-LOW, etc.).

Note 13: This specification is guaranteed but not tested. The limits represent propagation delays with 250 pF load capacitors in place of the 50 pF load capacitors in the standard AC load. This specification pertains to single output switching only.

Note 14: 3-STATE delays are load dominated and have been excluded from the datasheet.

Note 15: The Output Disable Time is dominated by the RC network (500 Ω , 250 pF) on the output and has been excluded from the datasheet.

Capacitance

$ \begin{array}{c cccc} \hline C_{\text{IN}} & & \text{Input Capacitance} & 4.5 & & \text{pF} & V_{\text{CC}} = 5.0V \\ \hline C_{\text{PD}} & & \text{Power Dissipation Capacitance} & 95 & & \text{pF} & V_{\text{CC}} = 5.0V \\ \hline \end{array} $	Symbol	Parameter	Тур	Units	Conditions
C_{PD} Power Dissipation Capacitance 95 pF $V_{CC} = 5.0 V$	C _{IN}	Input Capacitance	4.5	pF	$V_{CC} = 5.0V$
	C _{PD}	Power Dissipation Capacitance	95	pF	$V_{CC} = 5.0V$

FACT Noise Characteristics

The setup of a noise characteristics measurement is critical to the accuracy and repeatability of the tests. The following is a brief description of the setup used to measure the noise characteristics of FACT.

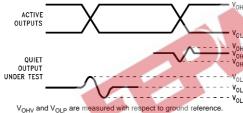
Equipment:

Hewlett Packard Model 8180A Word Generator PC-163A Test Fixture

Tektronics Model 7854 Oscilloscope

Procedure:

- Verify Test Fixture Loading: Standard Load 50 pF, 500Ω .
- Deskew the HFS generator so that no two channels have greater than 150 ps skew between them. This requires that the oscilloscope be deskewed first. It is important to deskew the HFS generator channels before testing. This will ensure that the outputs switch simultaneously.
- 3. Terminate all inputs and outputs to ensure proper loading of the outputs and that the input levels are at the correct voltage.
- 4. Set the HFS generator to toggle all but one output at a frequency of 1 MHz. Greater frequencies will increase DUT heating and effect the results of the measure-



Input pulses have the following characteristics: $f=1\ \text{MHz},\ t_r=3\ \text{ns},$ $t_f = 3 \text{ ns, skew} < 150 \text{ ps.}$

FIGURE 1. Quiet Output Noise Voltage Waveforms

5. Set the word generator input levels at 0V LOW and 3V HIGH for ACT devices and 0V LOW and 5V HIGH for AC devices. Verify levels with an oscilloscope.

V_{OLP}/V_{OLV} and V_{OHP}/V_{OHV} :

- Determine the quiet output pin that demonstrates the greatest noise levels. The worst case pin will usually be the furthest from the ground pin. Monitor the output voltages using a 50Ω coaxial cable plugged into a standard SMB type connector on the test fixture. Do not use an active FET probe.
- Measure $V_{\mbox{\scriptsize OLP}}$ and $V_{\mbox{\scriptsize OLV}}$ on the quiet output during the worst case transition for active and enable. Measure $V_{\mbox{\scriptsize OHP}}$ and $V_{\mbox{\scriptsize OHV}}$ on the quiet output during the worst case transition for active and enable.
- · Verify that the GND reference recorded on the oscilloscope has not drifted to ensure the accuracy and repeatability of the measurements.

V_{ILD} and V_{IHD} :

- Monitor one of the switching outputs using a 50Ω coaxial cable plugged into a standard SMB type connector on the test fixture. Do not use an active FET probe.
- First increase the input LOW voltage level, $V_{\rm IL}$, until the output begins to oscillate or steps out a min of 2 ns. Oscillation is defined as noise on the output LOW level that exceeds $V_{\rm IL}$ limits, or on output HIGH levels that exceed VIH limits. The input LOW voltage level at which oscillation occurs is defined as V_{ILD}.
- Next decrease the input HIGH voltage level, VIH, until the output begins to oscillate or steps out a min of 2 ns. Oscillation is defined as noise on the output LOW level that exceeds V_{IL} limits, or on output HIGH levels that exceed V_{IH} limits. The input HIGH voltage level at which oscillation occurs is defined as V_{IHD}.
- Verify that the GND reference recorded on the oscilloscope has not drifted to ensure the accuracy and repeatability of the measurements.

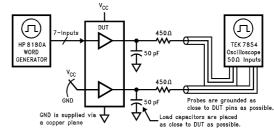
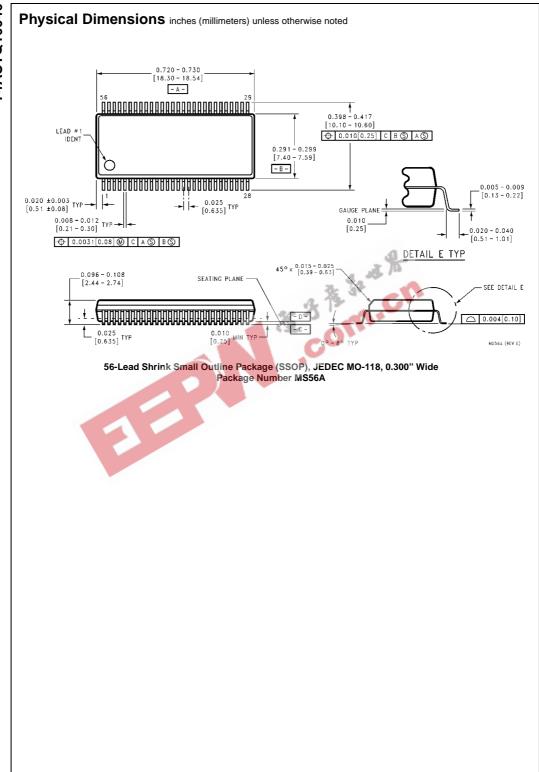
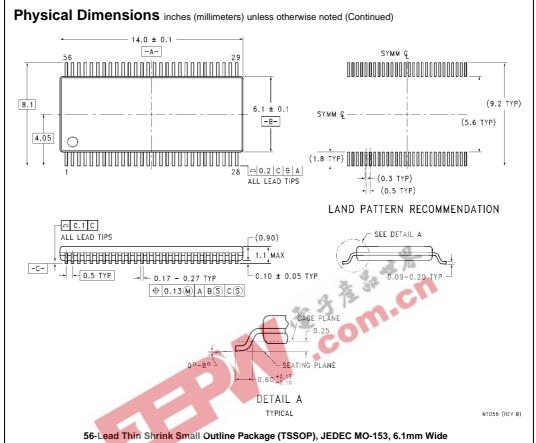


FIGURE 2. Simultaneous Switching Test Circuit





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Package Number MTD56

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- A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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